RECSEM REU 2017- Molecular Dynamics of Epoxy Resin Systems

Stephen Wu and Lam Tran Dr. Lonnie Crosby











Molecular Dynamics

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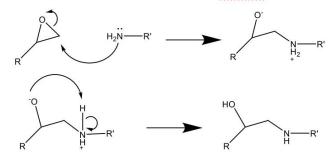
- Simulations that numerically solve the equations of motion for a system of particles as a function of time given a force field describing particle interactions.
- Microscopic length and time scales (nm/angstrom, ps/ns). Results "can be as accurate as needed".
- Relative to actual experiments, MD simulations can save time and money.
 Furthermore, they can oftentimes more easily reveal physical properties of a system (structure, microscopic interactions, etc.)

Epoxy Resins

Epoxy Resins

- First developed in the 1930s and used today in a wide range of applications.
- High strength/durability, low shrinkage and excellent adhesive and insulative properties.
- Composed of a base resin (BADGE, cycloaliphatic, biobased, etc.) and a hardener/curative (amine type, alkali, catalytic) that confers additional properties.

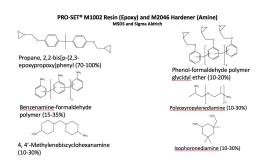
Epoxy – Amine Crosslinking Reaction (ReaxFF N/C/O/H)





Project Purpose and Goals-Why?

- Use MD simulations to examine the physical properties of the ProSet M1002 base resin/M2046 amine hardener system as a function of the components and the extent of crosslinking.
 - Glass Transition Temperature Tg
 - \circ ∂V terms- Thermal expansion coefficient α ($\sim \partial V/\partial T$), Isothermal compressibility κ ($\sim \partial V/\partial P$)
- How does the epoxy resin system adhere to aluminum surfaces?

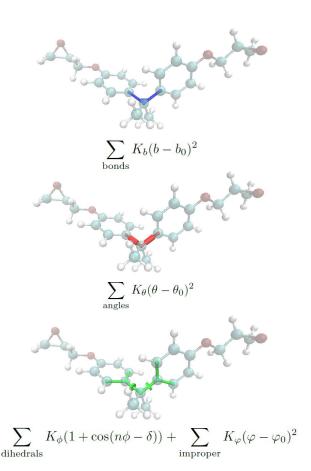




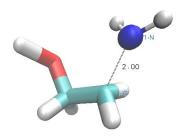
Overall Project Steps

- Parameterization of BADGE and 4, 4'-Methylenebiscyclohexanamine under CHARMM36 forcefield
 - o Individual parameterization of atomtype, atom, bond, angle and proper/improper dihedrals
 - o Packed molecule; Lowdin partial charge population analysis; and energy minimization
- Crosslinking of epoxy resin system
 - Activation of molecular structures; iterative, stepwise bond formation under distance cutoff
- Tests to determine physical properties of system
 - Cooling down simulation to ascertain glass transition temperature and coefficient of thermal expansion

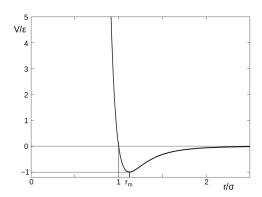
- Parameterization on each individual molecules
 - Construct topology files in OPLS-AA/CHARMM36
 - Bonded potential
 - Nonbonded potential
 - Structural optimization:
 - Spatial coordinates
 - Partial charge
- GROMACS sample test to calibrate and visualize the simulation system:
 - Water-solvated oxirane simulation
 - Methane-solvated oxirane simulation



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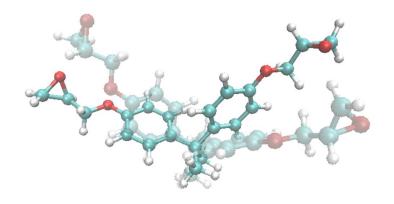


$$\sum_{\text{nonb,pair}} \frac{q_i q_j}{4\pi D r_{ij}}$$

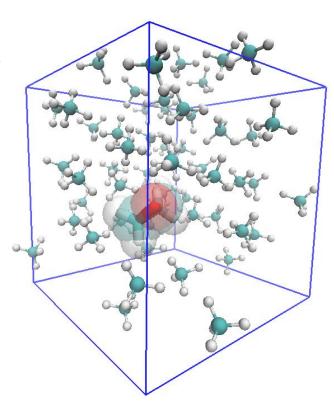


$$\sum_{\text{nonb,pair}} \varepsilon_{ij} \left[\left(\frac{R_{\min,ij}}{r_{ij}} \right)^{12} - 2 \left(\frac{R_{\min,ij}}{r_{ij}} \right)^{6} \right]$$

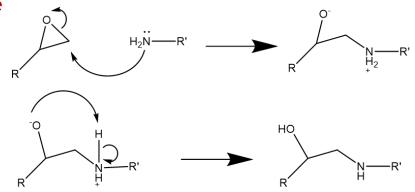
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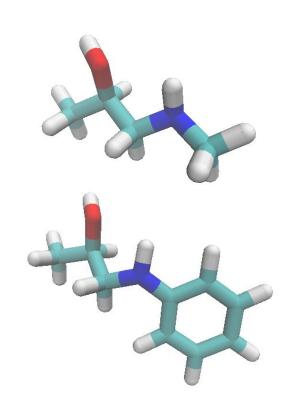
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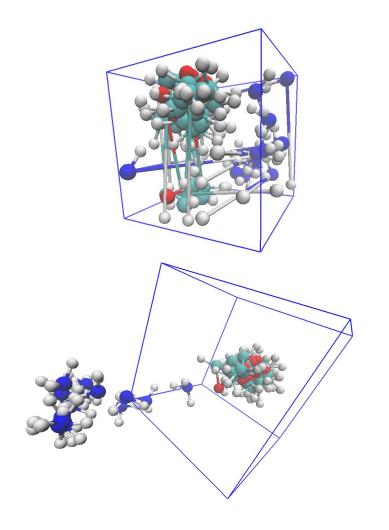
- Target reaction
 - Cross-linking bond between epoxide and amine
 - Crosslinked fragment parameterization
- LAMMPS ReaxFF simulation
 - CHONSSiNaAl.ff: (C/H/O/N/S/Si/Na/Al)
 - Non-activated system
 - Activated system
- LAMMPS nonreactive FF MD simulation
 - Activation of potential chemical reactive sites
 - Reconstruction of simulation box
 - Cross-linking process



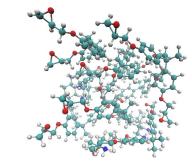
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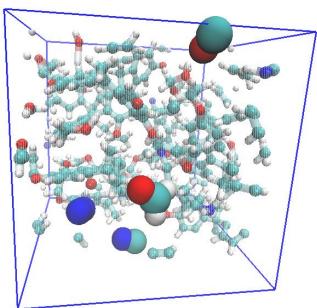


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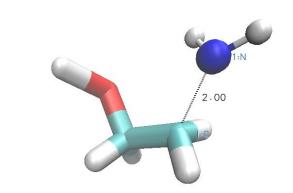


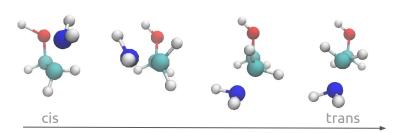
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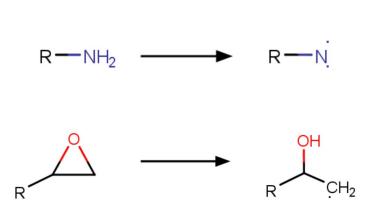


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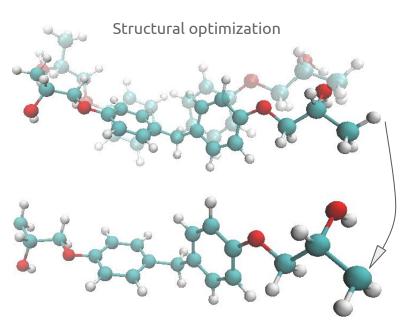


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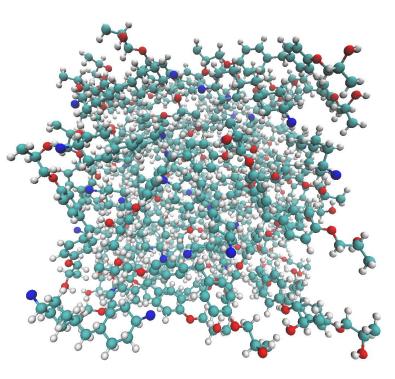


Rearrangement of partial charge

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BADGE - 4,4'-Methylenebiscyclohexanamine system

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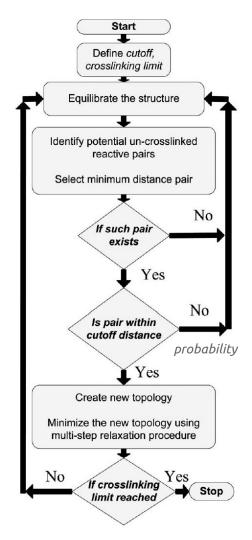


(40,20) system

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- LAMMPS nonreactive FF MD simulation
 - Activation of potential chemical reactive sites
 - Reconstruction of simulation box
 - Cross-linking process assumptions
 - Reactivity of primary and secondary amine
 - Hydrogen saturation

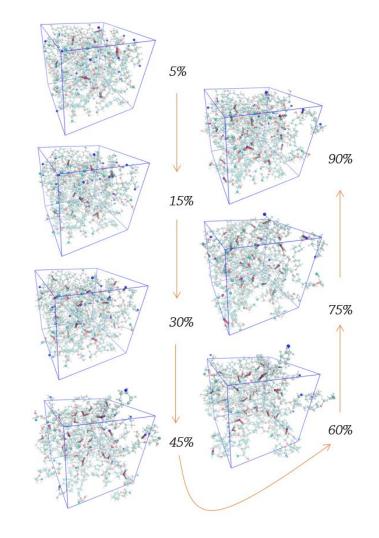
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 - Reconstruction of simulation box
 - Cross-linking process bond/create
 - Cut-off distance
 - Bond-forming probability

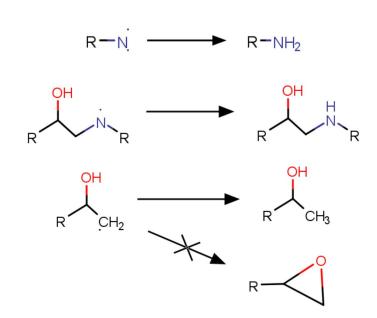


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 - Cross-linking process reaction coordinates

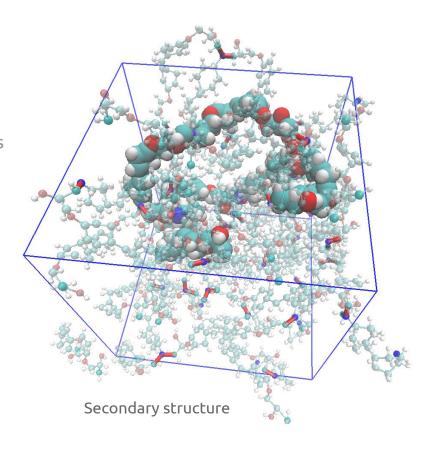
 $crosslinking \ percentage = 1 - \frac{noncrosslinked \ carbon \ radicals}{total \ potential \ crosslinks}$



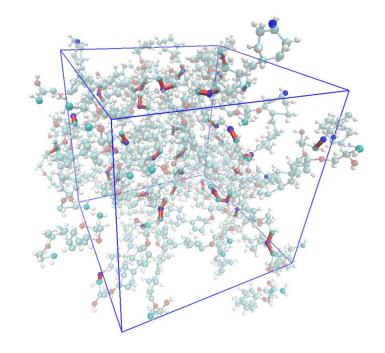
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 - Reconstruction of simulation box
 - Cross-linking process
 - Cross-linked structure deactivation
- Thermal and volumetric properties
 - Isobaric cooling simulation
 - Glass transition temperature Tg
 - Thermal expansion coefficient α
 - Isothermal depressurization simulation
 - Isothermal compressibility κ



- LAMMPS nonreactive FF MD simulation
 - Activation of potential chemical reactive sites
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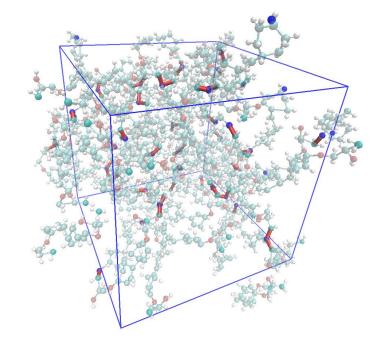
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(40,20) system with 98.75% cross-linking percentage

$$\alpha(P,\varepsilon) = \frac{1}{V} \left(\frac{\partial V}{\partial T} \right)_{P,\varepsilon}$$

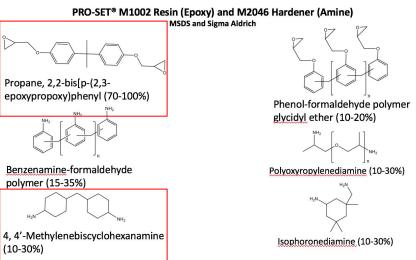
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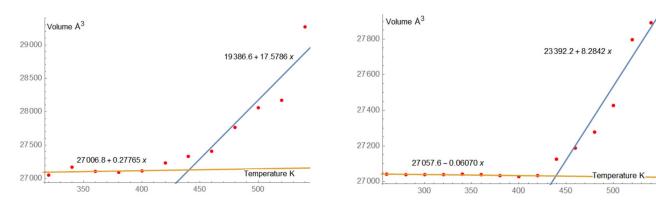
- In what ways does our project contribute to the study of epoxy resins using MD simulations?
 - Simulation of resin component molecules not previously studied and more molecules considered



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 - Creation of epoxy resin system with higher crosslinking percentage at a still-reasonable bond creation cutoff

| Authors | System | Cutoff Distance | Crosslinking Percentage | |
|-------------|--------------------------|-----------------|-------------------------|--|
| Us | BADGE/1761-71-3 | 12A | 98.75% | |
| Wang et al. | BADGE/isophorone diamine | 10A | 90.2% | |
| Wu & Xu | BADGE/isophorone diamine | 10A | 93.7% | |
| Choi et al. | EPON 862/TETA | 9A | 61% | |

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 - Simulation of resin component molecules not previously studied and more molecules considered
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References and Acknowledgements

- Wang, Zhikun, Qiang Lv, Shenghui Chen, Chunling Li, Shuangqing Sun, and Songqing Hu. "Glass transition investigations on highly crosslinked epoxy resins by molecular dynamics simulations." *Molecular Simulation* 41.18 (2015): 1515-527.
- Varshney, Vikas, Soumya S. Patnaik, Ajit K. Roy, and Barry L. Farmer. "A Molecular Dynamics Study of Epoxy-Based Networks: Cross-Linking Procedure and Prediction of Molecular and Material Properties." Macromolecules 41.18 (2008): 6837-842.
- Okabe, Tomonaga, Tomohiro Takehara, Keisuke Inose, Noriyuki Hirano, Masaaki Nishikawa, and Takuya Uehara. "Curing reaction of epoxy resin composed of mixed base resin and curing agent: Experiments and molecular simulation." Polymer 54.17 (2013): 4660-668.
- Fan, Hai Bo, and Matthew M.f. Yuen. "Material properties of the cross-linked epoxy resin compound predicted by molecular dynamics simulation." Polymer 48.7 (2007): 2174-178.
- Wu, Chaofu, and Weijian Xu. "Atomistic molecular modelling of crosslinked epoxy resin." Polymer 47.16 (2006): 6004-009.
- Choi, Joonmyung, Suyoung Yu, Seunghwa Yang, and Maenghyo Cho. "The glass transition and thermoelastic behavior of epoxy-based nanocomposites: A molecular dynamics study." Polymer 52.22 (2011): 5197-203.
- Wu, Chaofu, and Weijian Xu. "Atomistic molecular simulations of structure and dynamics of crosslinked epoxy resin." Polymer 48.19 (2007): 5802-812.

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